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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	59
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f2136csdfa-30

1.1.2 Specifications

Tables 1.1 and 1.2 outline Specifications.

Table 1.1 Specifications (1)

Item	Function	Description
CPU	Central processing unit	R8C CPU core • Number of fundamental instructions: 89 • Minimum instruction execution time: 50 ns (CPU clock = 20 MHz, VCC = 2.7 V to 5.5 V) 200 ns (CPU clock = 5 MHz, VCC = 1.8 V to 5.5 V) • Multiplier: 16 bits × 16 bits → 32 bits • Multiply-accumulate instruction: 16 bits × 16 bits + 32 bits → 32 bits • Operating mode: Single-chip mode (address space: 1 Mbyte)
Memory	ROM, RAM, data flash	Refer to Table 1.3 Product List .
Voltage detection	Voltage detection circuit	• Power-on reset • Voltage detection with three check points (the detection levels for voltage detection 0 and voltage detection 1 can be selected.)
I/O ports	Programmable I/O ports	• Input only: 1 • CMOS I/O: 59, selectable pull-up resistor • High current drive ports: 59
Clock	Clock generation circuits	• 4 circuits: XIN clock oscillation circuit, XCIN clock oscillation circuit, high-speed on-chip oscillator (with frequency adjustment function), low-speed on-chip oscillator • Oscillation stop detection: XIN clock oscillation stop detection function • Frequency divider circuit: Divided by 1, 2, 4, 8, or 16 can be selected • Low-power mode: Standard operating mode (high-speed clock, low-speed clock, high-speed on-chip oscillator, low-speed on-chip oscillator), wait mode, stop mode
Interrupts		• Number of interrupt vectors: 69 • External interrupt inputs: 9 (INT × 5, key input × 4) • Priority levels: 7
Event link controller (ELC)		• Events output from peripheral functions can be linked to events input to different peripheral functions. (30 sources × 10 types of event link operations) • Events can be handled independently from interrupt requests.
Watchdog timer		• 14 bits × 1 • Selectable reset start function • Selectable low-speed on-chip oscillator for the watchdog timer
DTC (data transfer controller)		• 1 channel • Activation sources: 27 • Transfer modes: 2 (normal mode, repeat mode)
Timer	Timers RJ_0	16 bits × 1: 1 circuit integrated on-chip Timer mode (periodic timer), pulse output mode (output level inverted every period), event counter mode, pulse width measurement mode, pulse period measurement mode
	Timer RB2_0	16 bits × 1: 1 circuit integrated on-chip Timer mode (periodic timer), programmable waveform generation mode (PWM output), programmable one-shot generation mode, programmable wait one-shot generation mode
	Timers RC_0	16 bits (with 4 capture/compare registers) × 1: 1 circuit integrated on-chip Timer mode (input capture function, output compare function), PWM mode (output: 3 pins), PWM2 mode (PWM output: 1 pin)
	Timer RE2	8 bits × 1 Compare match timer mode, real-time clock mode

1.3 Block Diagram

Figure 1.2 shows the Block Diagram.

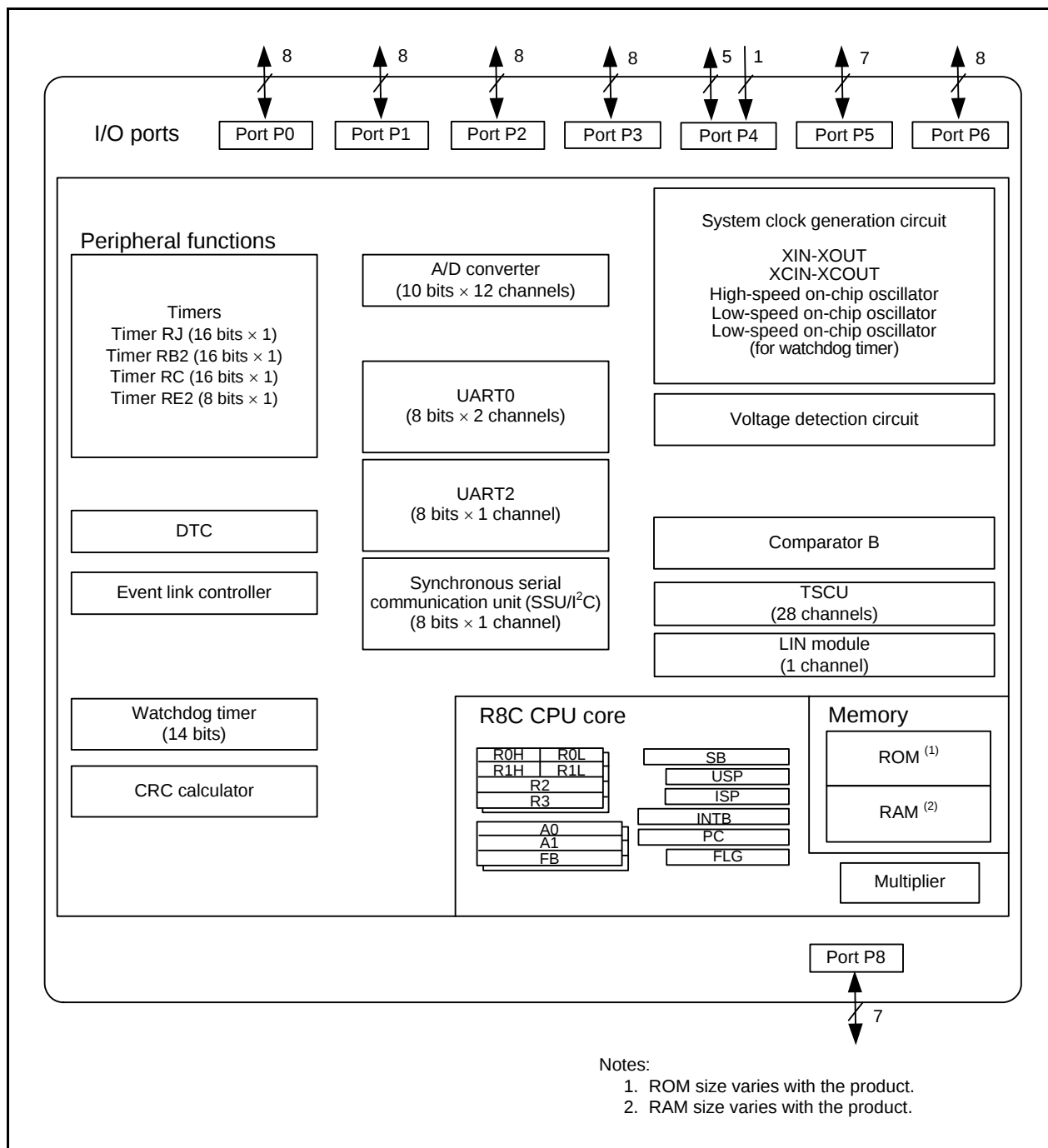


Figure 1.2 Block Diagram

1.4 Pin Assignment

Figure 1.3 shows Pin Assignment (Top View). Tables 1.4 to 1.6 list the Pin Name Information by Pin Number.

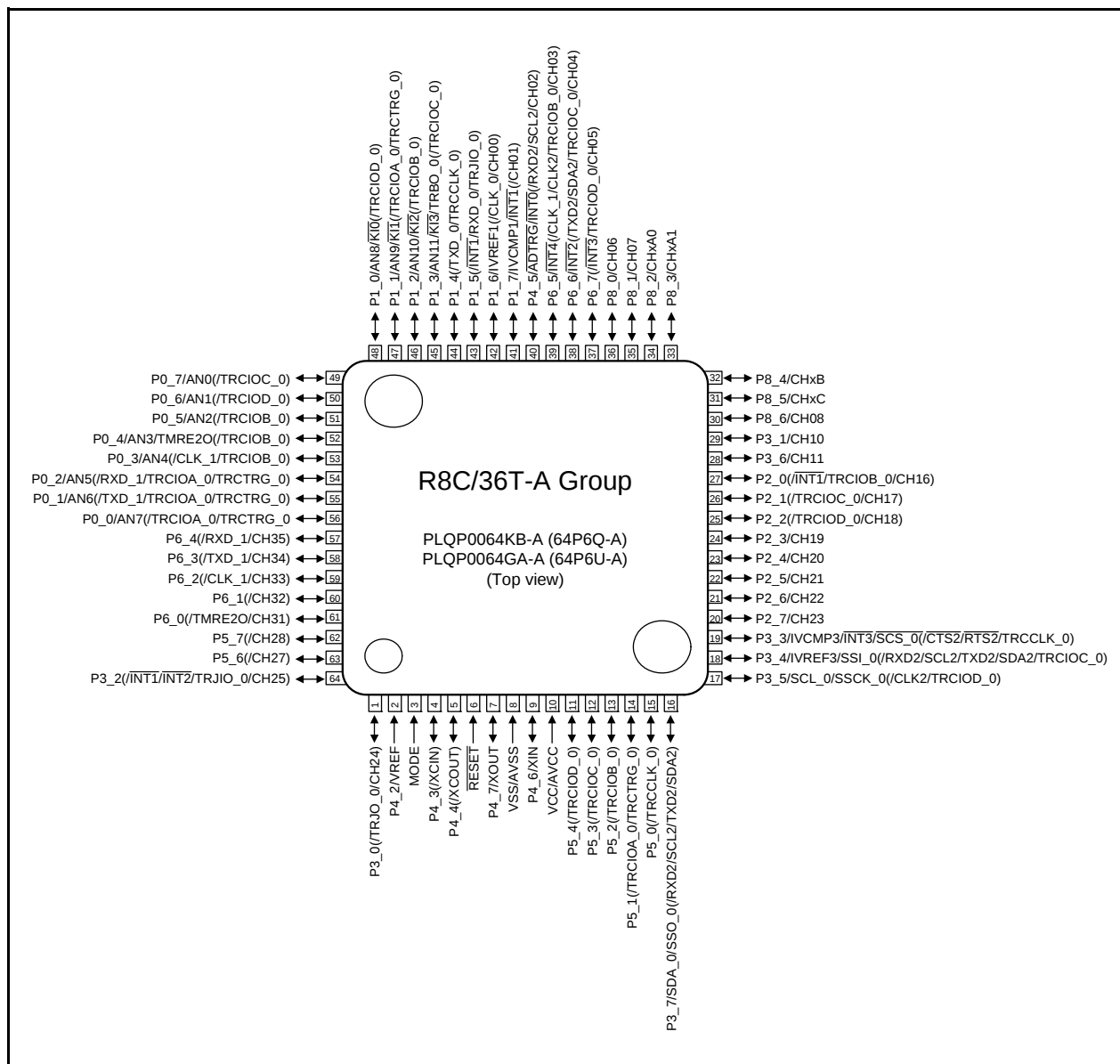


Figure 1.3 Pin Assignment (Top View)

Table 1.6 Pin Name Information by Pin Number (Timer RC, Timer RE2, and Others)

Port	Pin No.	Timer RC						Timer RE2	Others		
		TRCCLK_0	TRCIOA_0	TRCIOB_0	TRCIOC_0	TRCIOD_0	TRCTRG_0	TMRE2O			
P0_0	56		TRCIOA_0				TRCTRG_0		AN7		
P0_1	55		TRCIOA_0				TRCTRG_0		AN6		
P0_2	54		TRCIOA_0				TRCTRG_0		AN5		
P0_3	53			TRCIOB_0					AN4		
P0_4	52			TRCIOB_0				TMRE2O	AN3		
P0_5	51			TRCIOB_0					AN2		
P0_6	50					TRCIOD_0			AN1		
P0_7	49				TRCIOC_0				AN0		
P1_0	48					TRCIOD_0			AN8	K10	
P1_1	47		TRCIOA_0				TRCTRG_0		AN9	K11	
P1_2	46			TRCIOB_0					AN10	K12	
P1_3	45				TRCIOC_0				AN11	K13	
P1_4	44	TRCCLK_0									
P1_5	43										
P1_6	42								IVREF1		CH00
P1_7	41								IVCMP1		CH01
P2_0	27			TRCIOB_0							CH16
P2_1	26				TRCIOC_0						CH17
P2_2	25					TRCIOD_0					CH18
P2_3	24										CH19
P2_4	23										CH20
P2_5	22										CH21
P2_6	21										CH22
P2_7	20										CH23
P3_0	1										CH24
P3_1	29										CH10
P3_2	64										CH25
P3_3	19	TRCCLK_0							IVCMP3		
P3_4	18				TRCIOC_0				IVREF3		
P3_5	17					TRCIOD_0					
P3_6	28										CH11
P3_7	16										
P4_2	2								VREF		
P4_3	4								XCIN		
P4_4	5								XCOU		
P4_5	40								ADTRG		CH02
P4_6	9								XIN		
P4_7	7								XOUT		
P5_0	15	TRCCLK_0									
P5_1	14		TRCIOA_0				TRCTRG_0				
P5_2	13			TRCIOB_0							
P5_3	12				TRCIOC_0						
P5_4	11					TRCIOD_0					
P5_6	63										CH27
P5_7	62										CH28
P6_0	61							TMRE2O			CH31
P6_1	60										CH32
P6_2	59										CH33
P6_3	58										CH34
P6_4	57										CH35
P6_5	39			TRCIOB_0							CH03
P6_6	38				TRCIOC_0						CH04
P6_7	37					TRCIOD_0					CH05
P8_0	36										CH06
P8_1	35										CH07
P8_2	34										CHxA0
P8_3	33										CHxA1
P8_4	32										CHxB
P8_5	31										CHxC
P8_6	30										CH08

1.5 Pin Functions

Tables 1.7 and 1.8 list Pin Functions.

Table 1.7 Pin Functions (1)

Item	Pin Name	I/O	Description
Power supply input	VCC, VSS	—	Apply 1.8 V through 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	—	Power supply input for the A/D converter. Connect a capacitor between pins AVCC and AVSS.
Reset input	RESET	I	Applying a low level to this pin resets the MCU.
MODE	MODE	I	Connect this pin to the VCC pin via a resistor.
XIN clock input	XIN	I	I/O for the XIN clock generation circuit.
XIN clock output	XOUT	I/O	Connect a ceramic resonator or a crystal oscillator between pins XIN and XOUT. ⁽¹⁾ To use an external clock, input it to the XIN pin and leave the XOUT pin open.
XCIN clock input	XCIN	I	I/O for the XCIN clock generation circuit.
XCIN clock output	XCOUT	I/O	Connect a crystal oscillator between pins XCIN and XCOUT. ⁽¹⁾ To use an external clock, input it to the XCOUT pin and leave the XCIN pin open.
INT interrupt input	INT0 to INT4	I	INT interrupt input.
Key input interrupt	KI0 to KI3	I	Key input interrupt input.
Timer RJ_0	TRJIO_0	I/O	Input/output for timer RJ.
	TRJO_0	O	Output for timer RJ.
Timer RB2_0	TRBO_0	O	Output for timer RB2.
Timer RC_0	TRCLK_0	I	External clock input.
	TRCTR_0	I	External trigger input.
	TRCIOA_0, TRCIOB_0, TRCIOC_0, TRCIOD_0	I/O	Input/output for timer RC.
Timer RE2	TMRE2O	O	Divided clock output.
Serial interface (UART0)	CLK_0, CLK_1	I/O	Transfer clock input/output.
	RXD_0, RXD_1	I	Serial data input.
	TXD_0, TXD_1	O	Serial data output.
Serial interface (UART2)	CTS2	I	Input for transmission control.
	RTS2	O	Output for reception control.
	SCL2	I/O	I ² C mode clock input/output.
	SDA2	I/O	I ² C mode data input/output.
	RXD2	I	Serial data input.
	TXD2	O	Serial data output.
	CLK2	I/O	Transfer clock input/output.
Synchronous serial communication unit (SSU_0)	SSI_0	I/O	Data input/output.
	SCS_0	I/O	Chip-select input/output.
	SSCK_0	I/O	Clock input/output.
	SSO_0	I/O	Data input/output.
I ² C bus (I ² C_0)	SCL_0	I/O	Clock input/output.
	SDA_0	I/O	Data input/output.
Reference voltage input	VREF	I	Reference voltage input for the A/D converter.

Note:

1. Contact the oscillator manufacturer for oscillation characteristics.

3. Address Space

3.1 Memory Map

Figure 3.1 shows the Memory Map. The R8C/36T-A Group has a 1-Mbyte address space from addresses 00000h to FFFFFh. Up to 32 Kbytes of the internal ROM (program ROM) is allocated at lower addresses, beginning with address 0FFFFh. The area in excess of 32 Kbytes is allocated at higher addresses, beginning with address 10000h. For example, a 64-Kbyte internal ROM is allocated at addresses 08000h to 17FFFh. The fixed interrupt vector table is allocated at addresses 0FFDCh to 0FFFFh. The start address of each interrupt routine is stored here.

The internal ROM (data flash) is allocated at addresses 07000h to 07FFFh.

The internal RAM is allocated at higher addresses, beginning with address 00400h. For example, a 6-Kbyte internal RAM is allocated at addresses 00400h to 01BFFh. The internal RAM is used not only for data storage but also as a stack area when a subroutine is called or when an interrupt request is acknowledged.

Special function registers (SFRs) are allocated at addresses 00000h to 02FFFh and addresses 06800h to 06FFFh.

Peripheral function control registers are allocated here. All unallocated locations within the SFRs are reserved and cannot be accessed by users.

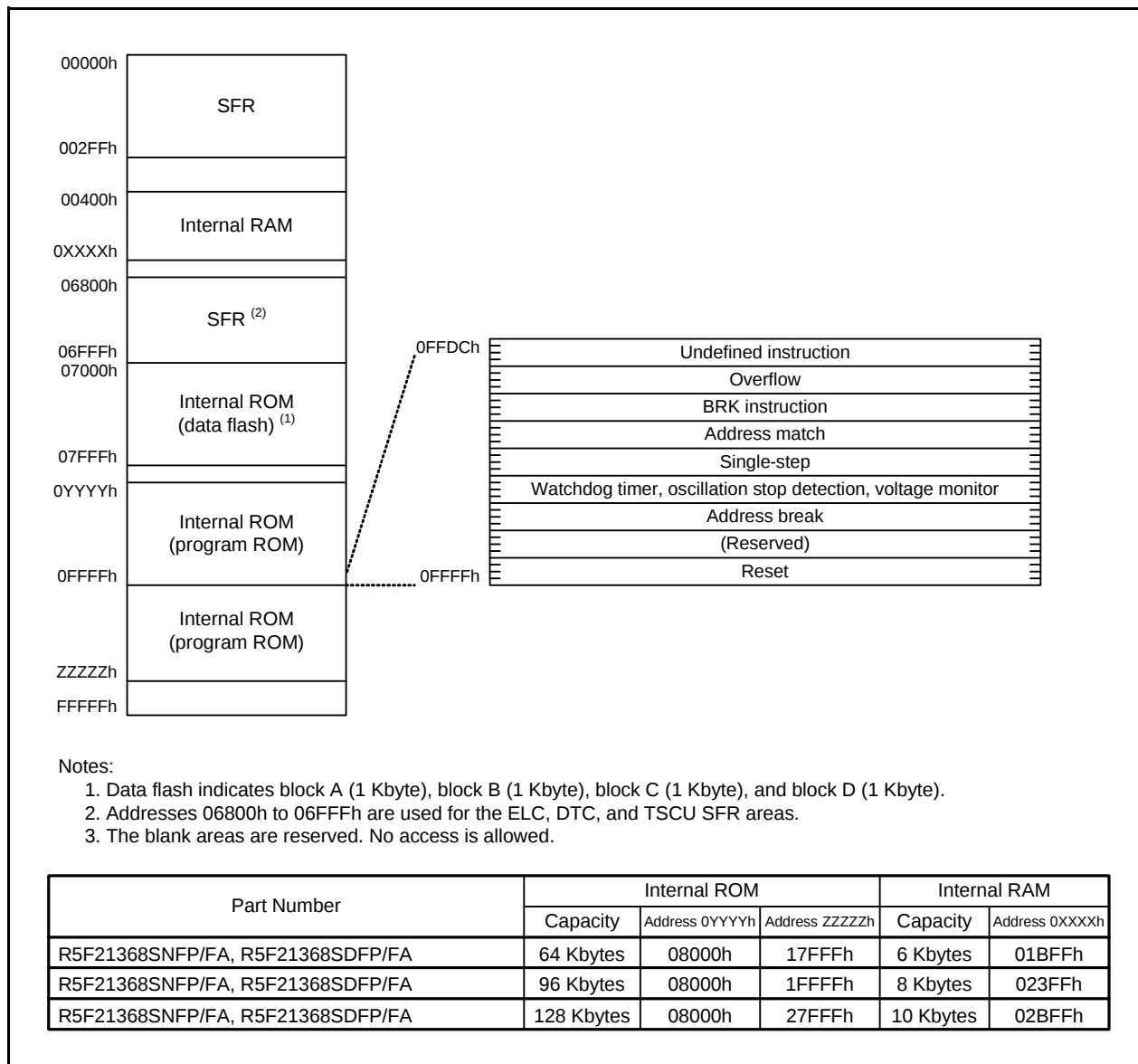


Figure 3.1 Memory Map

3.2 Special Function Registers (SFRs)

An SFR (special function register) is a control register for a peripheral function. Tables 3.1 to 3.16 list the SFR Information. Table 3.17 lists the ID code Area, Option Function Select Area.

Table 3.1 SFR Information (1) (1)

Address	Symbol	Register Name	After Reset	Remarks
00000h				
00001h				
00002h				
00003h				
00004h	PM0	Processor Mode Register 0	00h	
00005h	PM1	Processor Mode Register 1	10000000b	
00006h				
00007h	PRCR	Protect Register	00h	
00008h	CM0	System Clock Control Register 0	00101000b	
00009h	CM1	System Clock Control Register 1	00100000b	
0000Ah	OCD	Oscillation Stop Detection Register	00h	
0000Bh	CM3	System Clock Control Register 3	00h	
0000Ch	CM4	System Clock Control Register 4	00000001b	
0000Dh				
0000Eh				
0000Fh				
00010h	CPSRF	Clock Prescaler Reset Flag	00h	
00011h				
00012h	FRA0	High-Speed On-Chip Oscillator Control Register 0	00h	
00013h				
00014h	FRA2	High-Speed On-Chip Oscillator Control Register 2	00h	
00015h				
00016h				
00017h				
00018h				
00019h				
0001Ah				
0001Bh				
0001Ch				
0001Dh				
0001Eh				
0001Fh				
00020h	RISR	Reset Interrupt Select Register	10000000b or 00000000b	(Note 2)
00021h	WDTR	Watchdog Timer Reset Register	FFh	
00022h	WDTS	Watchdog Timer Start Register	FFh	
00023h	WDTC	Watchdog Timer Control Register	01111111b	
00024h	CSPR	Count Source Protection Mode Register	10000000b or 00000000b	(Note 2)
00025h				
00026h				
00027h				
00028h	RSTFR	Reset Source Determination Register	00XXXXXXb	
00029h				
0002Ah				
0002Bh				
0002Ch	SVDC	STBY VDC Power Control Register	00h	
0002Dh				
0002Eh				
0002Fh				
00030h	CMPA	Voltage Monitor Circuit Control Register	00h	
00031h	VCAC	Voltage Monitor Circuit Edge Select Register	00h	
00032h	OCVREFCR	On-Chip Reference Voltage Control Register	00h	
00033h				
00034h	VCA2	Voltage Detection Register 2	00000000b or 00100000b	(Note 3)
00035h				
00036h	VD1LS	Voltage Detection 1 Level Select Register	00000111b	
00037h				
00038h	VW0C	Voltage Monitor 0 Circuit Control Register	1100XX10b or 1100XX11b	(Note 3)
00039h	VW1C	Voltage Monitor 1 Circuit Control Register	10001010b	

X: Undefined

Notes:

1. The blank areas are reserved. No access is allowed.
2. Depends on the CSPROINI bit in the OFS register.
3. Depends on the LVDASI bit in the OFS register.

Table 3.4 SFR Information (4) (1)

Address	Symbol	Register Name	After Reset	Remarks
000BAh				
000BBh				
000BCh				
000BDh				
000BEh				
000BFh				
000C0h	U2MR	UART2 Transmit/Receive Mode Register	00h	
000C1h	U2BRG	UART2 Bit Rate Register	00h	
000C2h	U2TB	UART2 Transmit Buffer Register	00h	
000C3h			00h	
000C4h	U2C0	UART2 Transmit/Receive Control Register 0	00001000b	
000C5h	U2C1	UART2 Transmit/Receive Control Register 1	00000010b	
000C6h	U2RB	UART2 Receive Buffer Register	0000h	
000C7h				
000C8h	U2RXDF	UART2 Digital Filter Function Select Register	00h	
000C9h				
000CAh				
000CBh				
000CCh				
000CDh				
000CEh				
000CFh				
000D0h	U2SMR5	UART2 Special Mode Register 5	00h	
000D1h				
000D2h				
000D3h				
000D4h	U2SMR4	UART2 Special Mode Register 4	00h	
000D5h	U2SMR3	UART2 Special Mode Register 3	00h	
000D6h	U2SMR2	UART2 Special Mode Register 2	00h	
000D7h	U2SMR	UART2 Special Mode Register	00h	
000D8h				
000D9h				
000DAh				
000DBh				
000DCh				
000DDh				
000DEh				
000DFh				
000E0h	IICCR_0	I ² C_0 Control Register	00001110b	
000E1h	SSBR_0	SS_0 Bit Counter Register	11111000b	
000E2h	SITDR_0	SI_0 Transmit Data Register	FFh	
000E3h			FFh	
000E4h	SIRDR_0	SI_0 Receive Data Register	FFh	
000E5h			FFh	
000E6h	SICR1_0	SI_0 Control Register 1	00h	
000E7h	SICR2_0	SI_0 Control Register 2	01111101b	
000E8h	SIMR1_0	SI_0 Mode Register 1	00010000b	
000E9h	SIER_0	SI_0 Interrupt Enable Register	00h	
000EAh	SISR_0	SI_0 Status Register	00h	
000EBh	SIMR2_0	SI_0 Mode Register 2	00h	
000ECh				
000EDh				
000EEh				
000EFh				
000F0h				
000F1h				
000F2h				
000F3h				
000F4h				
000F5h				
000F6h				
000F7h				
000F8h				
000F9h				

Note:

1. The blank areas are reserved. No access is allowed.

Table 3.9 SFR Information (9) (1)

Address	Symbol	Register Name	After Reset	Remarks
00280h	DTCTL	DTC Activation Control Register	00h	
00281h				
00282h				
00283h				
00284h				
00285h				
00286h				
00287h				
00288h	DTCEN0	DTC Activation Enable Register 0	00h	
00289h	DTCEN1	DTC Activation Enable Register 1	00h	
0028Ah	DTCEN2	DTC Activation Enable Register 2	00h	
0028Bh	DTCEN3	DTC Activation Enable Register 3	00h	
0028Ch				
0028Dh	DTCEN5	DTC Activation Enable Register 5	00h	
0028Eh	DTCEN6	DTC Activation Enable Register 6	00h	
0028Fh				
00290h	CRCSAR	SFR Snoop Address Register	0000h	
00291h				
00292h	CRCMR	CRC Control Register	00h	
00293h				
00294h	CRCD	CRC Data Register	0000h	
00295h				
00296h	CRCIN	CRC Input Register	00h	
00297h				
00298h				
00299h				
0029Ah				
0029Bh				
0029Ch				
0029Dh				
0029Eh				
0029Fh				
002A0h	TRJ_0SR	Timer RJ_0 Pin Select Register	08h	
002A1h				
002A2h				
002A3h				
002A4h				
002A5h	TRCLKSR	Timer RCCLK Pin Select Register	00h	
002A6h	TRC_0SR0	Timer RC_0 Pin Select Register 0	00h	
002A7h	TRC_0SR1	Timer RC_0 Pin Select Register 1	00h	
002A8h				
002A9h				
002AAh				
002ABh				
002ACh				
002ADh	TIMSR	Timer Pin Select Register	00h	
002AEh	U_0SR	UART0_0 Pin Select Register	00h	
002AFh	U_1SR	UART0_1 Pin Select Register	00h	
002B0h				
002B1h				
002B2h	U2SR0	UART2 Pin Select Register 0	00h	
002B3h	U2SR1	UART2 Pin Select Register 1	00h	
002B4h				
002B5h				
002B6h	INTSR0	INT Interrupt Input Pin Select Register 0	00h	
002B7h				
002B8h				
002B9h	PINSR	I/O Function Pin Select Register	00h	
002BAh				
002BBh				
002BCh				
002BDh				
002BEh	PMCSEL	Pin Assignment Select Register	00h	
002BFh				

Note:

1. The blank areas are reserved. No access is allowed.

Table 3.12 SFR Information (12) ⁽¹⁾

Address	Symbol	Register Name	After Reset	Remarks
06B00h	TSCUCR0	TSCU Control Register 0	0000h	
06B01h				
06B02h	TSCUCR1	TSCU Control Register 1	000000000010000b	
06B03h				
06B04h	TSCUMR	TSCU Mode Register	000000001000000b	
06B05h				
06B06h	TSCUTCRA	TSCU Timing Control Register 0A	000000000111111b	
06B07h				
06B08h	TSCUTCROB	TSCU Timing Control Register 0B	000000000111111b	
06B09h				
06B0Ah	TSCUTCRI	TSCU Timing Control Register 1	0000000000000001b	
06B0Bh				
06B0Ch	TSCUTCRI2	TSCU Timing Control Register 2	0000h	
06B0Dh				
06B0Eh	TSCUTCRI3	TSCU Timing Control Register 3	0000h	
06B0Fh				
06B10h	TSCUCHC	TSCU Channel Control Register	0011111100000000b	
06B11h				
06B12h	TSCUFR	TSCU Flag Register	0000h	
06B13h				
06B14h	TSCUSTC	TSCU Status Counter Register	0000h	
06B15h				
06B16h	TSCUSCS	TSCU Secondary Counter Set Register	000000000010000b	
06B17h				
06B18h	TSCUSCC	TSCU Secondary Counter	000000000010000b	
06B19h				
06B1Ah	TSCUDBR	TSCU Data Buffer Register	0000h	
06B1Bh				
06B1Ch	TSCUPRC	TSCU Primary Counter	0000h	
06B1Dh				
06B1Eh	TSCURVR0	TSCU Random Value Store Register 0	0000h	
06B1Fh				
06B20h	TSCURVR1	TSCU Random Value Store Register 1	0000h	
06B21h				
06B22h	TSCURVR2	TSCU Random Value Store Register 2	0000h	
06B23h				
06B24h	TSCURVR3	TSCU Random Value Store Register 3	0000h	
06B25h				
06B26h	TSIE0	TSCU Input Enable Register 0	0000h	
06B27h				
06B28h	TSIE1	TSCU Input Enable Register 1	0000h	
06B29h				
06B2Ah	TSIE2	TSCU Input Enable Register 2	0000h	
06B2Bh				
06B2Ch	TSCHSEL0	TSCUCHXA Select Register 0	0000h	
06B2Dh				
06B2Eh	TSCHSEL1	TSCUCHXA Select Register 1	0000h	
06B2Fh				
06B30h	TSCHSEL2	TSCUCHXA Select Register 2	0000h	
06B31h				
06B32h to 06BFFh				
06C00h		Area for storing DTC transfer vector 0	XXh	
06C01h		Area for storing DTC transfer vector 1	XXh	
06C02h		Area for storing DTC transfer vector 2	XXh	
06C03h		Area for storing DTC transfer vector 3	XXh	
06C04h		Area for storing DTC transfer vector 4	XXh	
06C05h				
06C06h				
06C07h				
06C08h		Area for storing DTC transfer vector 8	XXh	
06C09h		Area for storing DTC transfer vector 9	XXh	

X: Undefined

Note:

1. The blank areas are reserved. No access is allowed.

Table 3.13 SFR Information (13) ⁽¹⁾

Address	Symbol	Register Name	After Reset	Remarks
06C0Ah		Area for storing DTC transfer vector 10	XXh	
06C0Bh		Area for storing DTC transfer vector 11	XXh	
06C0Ch		Area for storing DTC transfer vector 12	XXh	
06C0Dh		Area for storing DTC transfer vector 13	XXh	
06C0Eh		Area for storing DTC transfer vector 14	XXh	
06C0Fh		Area for storing DTC transfer vector 15	XXh	
06C10h		Area for storing DTC transfer vector 16	XXh	
06C11h		Area for storing DTC transfer vector 17	XXh	
06C12h		Area for storing DTC transfer vector 18	XXh	
06C13h		Area for storing DTC transfer vector 19	XXh	
06C14h				
06C15h				
06C16h		Area for storing DTC transfer vector 22	XXh	
06C17h		Area for storing DTC transfer vector 23	XXh	
06C18h		Area for storing DTC transfer vector 24	XXh	
06C19h		Area for storing DTC transfer vector 25	XXh	
06C1Ah				
06C1Bh				
06C1Ch				
06C1Dh				
06C1Eh				
06C1Fh				
06C20h				
06C21h				
06C22h				
06C23h				
06C24h				
06C25h				
06C26h				
06C27h				
06C28h				
06C29h				
06C2Ah		Area for storing DTC transfer vector 42	XXh	
06C2Bh				
06C2Ch				
06C2Dh				
06C2Eh				
06C2Fh				
06C30h				
06C31h		Area for storing DTC transfer vector 49	XXh	
06C32h				
06C33h		Area for storing DTC transfer vector 51	XXh	
06C34h		Area for storing DTC transfer vector 52	XXh	
06C35h		Area for storing DTC transfer vector 53	XXh	
06C36h		Area for storing DTC transfer vector 54	XXh	
06C37h				
06C38h				
06C39h				
06C3Ah				
06C3Bh				
06C3Ch				
06C3Dh				
06C3Eh				
06C3Fh				
06C40h	DTCCR0	DTC Control Register 0	XXh	
06C41h	DTBLS0	DTC Block Size Register 0	XXh	
06C42h	DTCC0	DTC Transfer Count Register 0	XXh	
06C43h	DTRL0	DTC Transfer Count Reload Register 0	XXh	
06C44h	DTSAR0	DTC Source Address Register 0	XXXXh	
06C45h				
06C46h	DTDAR0	DTC Destination Address Register 0	XXXXh	
06C47h				
06C48h	DTCCR1	DTC Control Register 1	XXh	
06C49h	DTBLS1	DTC Block Size Register 1	XXh	

X: Undefined

Note:

1. The blank areas are reserved. No access is allowed.

4. Electrical Characteristics

4.1 Absolute Maximum Ratings

Table 4.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Rated Value	Unit
V _{CC} /A _V CC I _{CE} V _{CC}	Supply voltage		–0.3 to 6.5	V
V _I	Input voltage		–0.3 to V _{CC} + 0.3	V
V _O	Output voltage		–0.3 to V _{CC} + 0.3	V
P _d	Power dissipation	–40°C ≤ T _{opr} ≤ 85°C	500	mW
T _{opr}	Operating ambient temperature		–20 to 85 (N version)/ –40 to 85 (D version)	°C
T _{stg}	Storage temperature		–65 to 150	°C

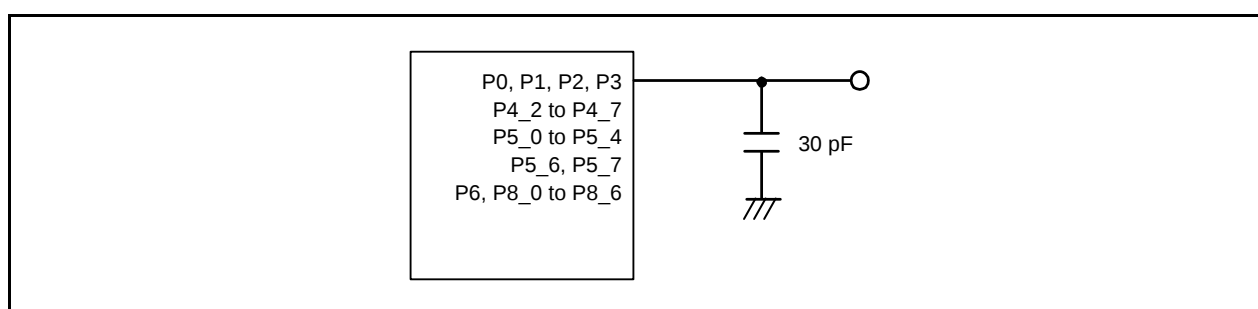


Figure 4.1 Timing Measurement Circuit for Ports P0, P1, P2, P3, P4_2 to P4_7, P5_0 to P5_4, P5_6, P5_7, P6, and P8_0 to P8_6

Table 4.8 Voltage Detection 1 Circuit Characteristics
(Measurement conditions: Vcc = 1.8 V to 5.5 V, Topr = –20°C to 85°C (N version)/
–40°C to 85°C (D version))

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
Vdet1	Voltage detection level Vdet1_0 ⁽¹⁾	When Vcc falls	2.00	2.20	2.40	V
	Voltage detection level Vdet1_1 ⁽¹⁾	When Vcc falls	2.15	2.35	2.55	V
	Voltage detection level Vdet1_2 ⁽¹⁾	When Vcc falls	2.30	2.50	2.70	V
	Voltage detection level Vdet1_3 ⁽¹⁾	When Vcc falls	2.45	2.65	2.85	V
	Voltage detection level Vdet1_4 ⁽¹⁾	When Vcc falls	2.60	2.80	3.00	V
	Voltage detection level Vdet1_5 ⁽¹⁾	When Vcc falls	2.75	2.95	3.15	V
	Voltage detection level Vdet1_6 ⁽¹⁾	When Vcc falls	2.80	3.10	3.40	V
	Voltage detection level Vdet1_7 ⁽¹⁾	When Vcc falls	2.95	3.25	3.55	V
	Voltage detection level Vdet1_8 ⁽¹⁾	When Vcc falls	3.10	3.40	3.70	V
	Voltage detection level Vdet1_9 ⁽¹⁾	When Vcc falls	3.25	3.55	3.85	V
	Voltage detection level Vdet1_A ⁽¹⁾	When Vcc falls	3.40	3.70	4.00	V
	Voltage detection level Vdet1_B ⁽¹⁾	When Vcc falls	3.55	3.85	4.15	V
	Voltage detection level Vdet1_C ⁽¹⁾	When Vcc falls	3.70	4.00	4.30	V
	Voltage detection level Vdet1_D ⁽¹⁾	When Vcc falls	3.85	4.15	4.45	V
	Voltage detection level Vdet1_E ⁽¹⁾	When Vcc falls	4.00	4.30	4.60	V
	Voltage detection level Vdet1_F ⁽¹⁾	When Vcc falls	4.15	4.45	4.75	V
—	Hysteresis width at the rising of Vcc in voltage detection 1 circuit	Vdet1_0 to Vdet1_5 selected	—	0.07	—	V
		Vdet1_6 to Vdet1_F selected	—	0.10	—	V
—	Voltage detection 1 circuit response time ⁽²⁾	At the falling of Vcc from 5 V to (Vdet1 – 0.1) V	—	60	150	μs
—	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	—	1.7	—	μA
t _{d(E-A)}	Waiting time until voltage detection circuit operation starts ⁽³⁾		—	—	100	μs

Notes:

1. Select the voltage detection level with bits VD1S0 to VD1S3 in the VD1LS register.
2. Time until the voltage monitor 1 interrupt request is generated after the voltage passes V_{det1}.
3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.

Table 4.9 Voltage Detection 2 Circuit Characteristics
(Measurement conditions: Vcc = 1.8 V to 5.5 V, Topr = –20°C to 85°C (N version)/
–40°C to 85°C (D version))

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
Vdet2	Voltage detection level Vdet2_0	When Vcc falls	3.70	4.00	4.30	V
—	Hysteresis width at the rising of Vcc in voltage detection 2 circuit		—	0.1	—	μs
—	Voltage detection 2 circuit response time ⁽¹⁾	At the falling of Vcc from 5 V to (Vdet2_0 – 0.1) V	—	20	150	μs
—	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0 V	—	1.7	—	μA
t _{d(E-A)}	Waiting time until voltage detection circuit operation starts ⁽²⁾		—	—	100	μs

Notes:

1. Time until the voltage monitor 2 interrupt request is generated after the voltage passes V_{det2}.
2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.

Table 4.12 Low-Speed On-Chip Oscillator Circuit Characteristics
(Measurement conditions: Vcc = 1.8 V to 5.5 V, Topr = –20°C to 85°C (N version)/
–40°C to 85°C (D version))

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
fLOCO	Low-speed on-chip oscillator frequency		60	125	250	kHz
—	Oscillation stability time	Vcc = 5.0 V, Topr = 25°C	—	30	100	μs
—	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	—	3	—	μA

Table 4.13 Power Supply Circuit Characteristics
(Measurement conditions: Vcc = 1.8 V to 5.5 V, Topr = –20°C to 85°C (N version)/
–40°C to 85°C (D version))

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
td(P-R)	Time for internal power supply stabilization during power-on ⁽¹⁾		—	—	2,000	μs

Note:

1. Waiting time until the internal power supply generation circuit stabilizes during power-on.

Table 4.19 DC Characteristics (6) [1.8 V ≤ V_{CC} < 2.7 V]
(Topr = −20°C to 85°C (N version)/−40°C to 85°C (D version), unless otherwise specified)

Symbol	Parameter		Conditions							Standard (4)			Unit
			Oscillation		On-Chip Oscillator		CPU Clock	Low-Power-Consumption Setting	Other	Min.	Typ.	Max.	
			XIN (2)	XCIN	High-Speed	Low-Speed							
Icc	Power supply current (1)	High-speed clock mode	5 MHz	Off	Off	125 kHz	No division	—		—	2.2	—	mA
			5 MHz	Off	Off	125 kHz	Divide-by-8	—		—	0.8	—	mA
		High-speed on-chip oscillator mode	Off	Off	5 MHz (3)	125 kHz	No division	—		—	2.5	10	mA
			Off	Off	5 MHz (3)	125 kHz	Divide-by-8	—		—	1.7	—	mA
			Off	Off	4 MHz (3)	125 kHz	Divide-by-16	MSTIIC = 1 MSTTRC = 1		—	1	—	mA
		Low-speed on-chip oscillator mode	Off	Off	Off	125 kHz	Divide-by-8	FMR27 = 1 SVC0 = 0		—	90	300	μA
		Low-speed clock mode	Off	32 kHz	Off	Off	No division	FMR27 = 1 SVC0 = 0		—	80	350	μA
		Wait mode	Off	Off	Off	125 kHz	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 SVC0 = 1	While a WAIT instruction is executed Peripheral clock operation	—	15	90	μA
			Off	Off	Off	125 kHz	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 SVC0 = 1	While a WAIT instruction is executed Peripheral clock off	—	4	80	μA
			Off	32 kHz	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 SVC0 = 1	While a WAIT instruction is executed Peripheral clock off	—	3.5	—	μA
		Stop mode	Off	Off	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 25°C Peripheral clock off	—	2.2	6	μA
			Off	Off	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 85°C Peripheral clock off	—	30	—	μA

Notes:

1. V_{CC} = 1.8 V to 2.7 V, single-chip mode, output pins are open, and other pins are V_{SS}.
2. XIN is set to square wave input.
3. fHOCO-F
4. The typical value (Typ.) indicates the current value when the CPU and the memory operate.
The maximum value (Max.) indicates the current value when the CPU, the memory, and the peripheral functions operate and the flash memory is programmed/erased.

**Table 4.21 Timing Requirements of Clock Synchronous Serial I/O with Chip Select
(during Slave Operation)**
(Measurement conditions: $V_{CC} = 1.8\text{ V to }5.5\text{ V}$, $T_{opr} = -20^{\circ}\text{C to }85^{\circ}\text{C}$ (N version)/
 $-40^{\circ}\text{C to }85^{\circ}\text{C}$ (D version))

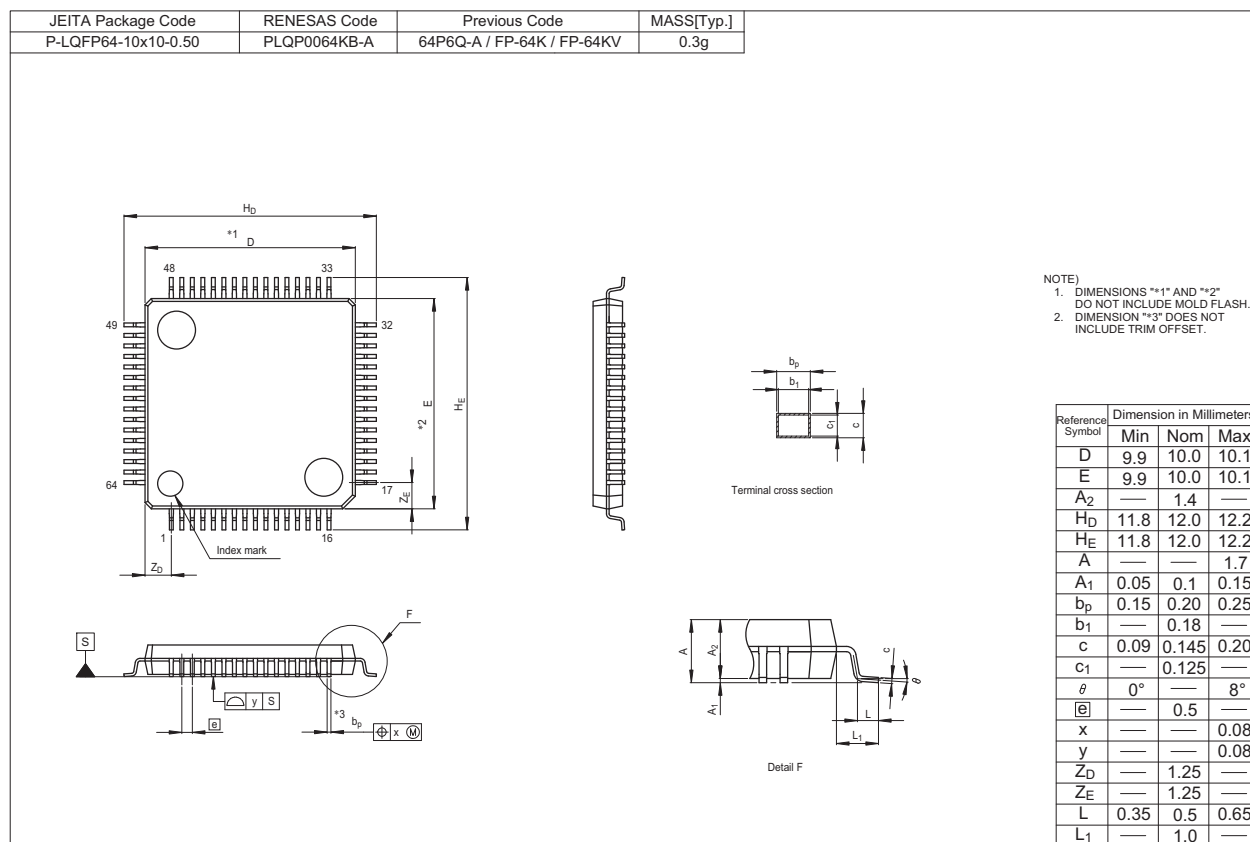
Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
tsucyc	SSCK clock cycle time		4.00	—	—	tcyc (1)
tHI	SSCK clock high width		0.40	—	0.60	tsucyc
tLO	SSCK clock low width		0.40	—	0.60	tsucyc
trISE	SSCK clock rising time		—	—	1.00	μs
trFALL	SSCK clock falling time		—	—	1.00	μs
tsu	SSO data input setup time		10.00	—	—	ns
tH	SSO data input hold time		2.00	—	—	tcyc (1)
tLEAD	$\overline{\text{SCS}}$ setup time		1tcyc + 50	—	—	ns
tLAG	$\overline{\text{SCS}}$ hold time		1tcyc + 50	—	—	ns
tOD	SSI, SSO data output delay time	$4.5\text{ V} \leq V_{CC} \leq 5.5\text{ V}$	—	—	60	ns
		$2.7\text{ V} \leq V_{CC} < 4.5\text{ V}$	—	—	70	ns
		$1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$	—	—	100.00	ns
tsA	SSI slave access time	$2.7\text{ V} \leq V_{CC} \leq 5.5\text{ V}$	—	—	1.5tcyc + 100	ns
		$1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$	—	—	1.5tcyc + 200	ns
toR	SSI slave out open time	$2.7\text{ V} \leq V_{CC} \leq 5.5\text{ V}$	—	—	1.5tcyc + 100	ns
		$1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$	—	—	1.5tcyc + 200	ns

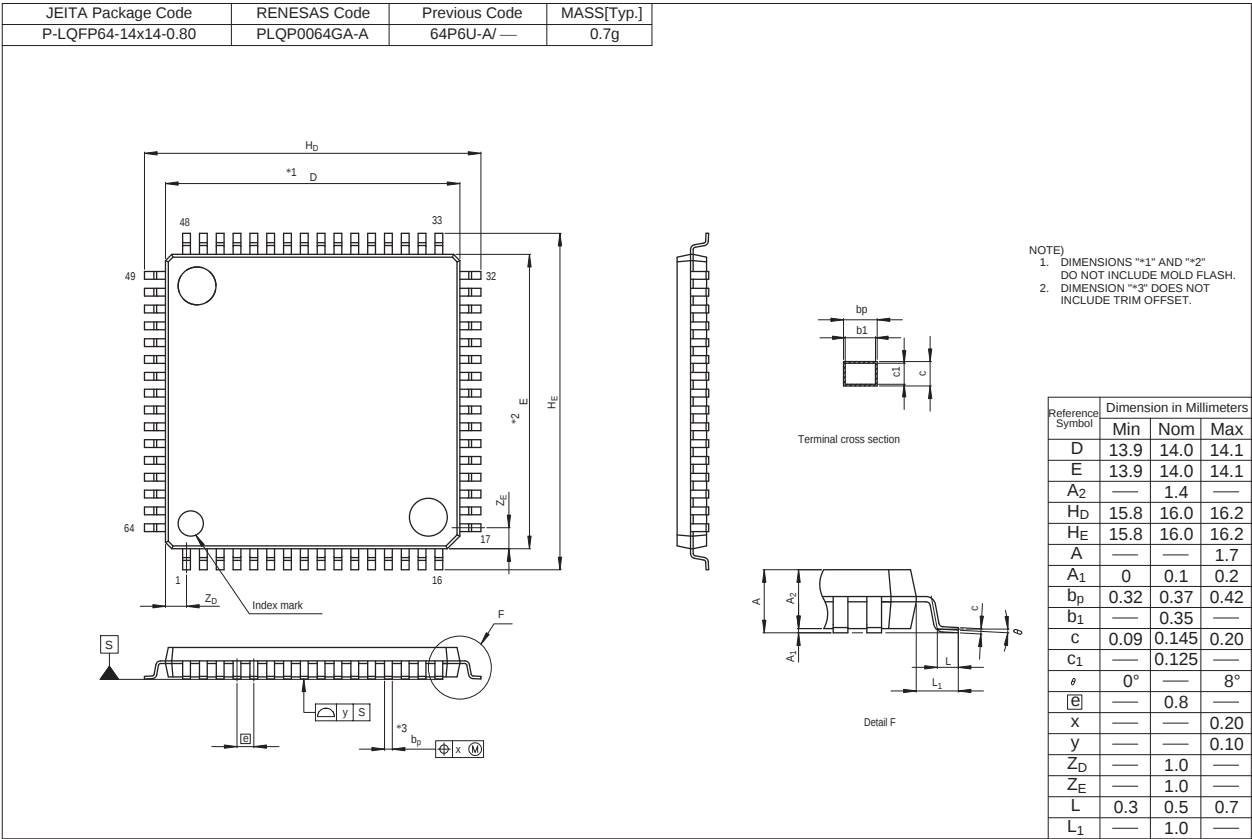
Note:

1. 1tcyc = 1/f1 (s)

Appendix 1. Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the “Packages” section of the Renesas Electronics website.





REVISION HISTORY	R8C/36T-A Group Datasheet
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Rev.	Date	Description	
		Page	Summary
0.01	Feb 23, 2011	—	First Edition issued
1.00	Dec 09, 2011	All pages	"Preliminary", "Under development" deleted, "sensor control unit" → "touch sensor control unit"
		2, 3	Tables 1.1 and 1.2 revised
		6	Figure 1.3 "P3_10/CH10" → "P3_1/CH10"
		11	Table 1.8 "Touch sensor control unit" added
		13	2.1 revised
		16, 17, 19 to 22, 24 to 28	Tables 3.1, 3.2, 3.4 to 3.7, 3.9 to 3.13
		32	Table 3.17 revised, Note 2 added
		33 to 56	"4. Electrical Characteristics" added

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